



Product Change Notification

Change Notification #: 116754 - 00
Change Title: Intel® Dual Band Wireless-AC 8265 SKUs:
8265.D2WMLG; 8265.D2WMLG.NV;
8265.D2WMLG.S; 8265.D2WMLG.NVS;
8265.D2WMLGH; 8265.D2WMLG.NVH
PCN 116754-00, Label, Update Japan
Regulatory Label
Date of Publication: February 05, 2019

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	February 20, 2019
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Description of Change to the Customer:

The Intel® Wireless-AC 8265 SKUs listed in the products affected table below will undergo the following changes:

- Update to current Japan regulatory marking as detailed in the images below:



8265.D2WMLG Reel Label (Before)

	8265.D2WMLG	R/ID: XXXXXXXXXX	QTY: XXXX
MM #: XXXXXX	TA: J29934-005	HP P/N: XXXXXX-XXX	REV XX
T P/N: GTTTTTTTTTT	XXXX-XXXXXXXXXXXX		
L P/N: SW10K97515	D P/N: PPPPPP	REV AXX	

8265.D2WMLG Reel Label (After)

	8265.D2WMLG	R/ID: XXXXXXXXXX	QTY: XXXX
MM #: XXXXXX	TA: J29934-005	HP P/N: XXXXXX-XXX	REV XX
T P/N: GTTTTTTTTTT	XXXX-XXXXXXXXXXXX		
L P/N: SW10K97515	D P/N: PPPPPP	REV AXX	

8265.D2WMLG MBB Label (Before)

8265.D2WMLG	QTY: 1000	Intel® Dual Band Wireless-AC XXXX (Model: XXXXXXX)
VERSION #: J29934-005	MM#: XXXXXX	PKG ID (S): VVVVMMMMDDDDSSSSPPPPPP100
MADE IN CHINA WITH PARTIAL FOREIGN CONTENT	PACK DATE: DD MM YY	D P/N: PPPPPP REV AXX
CARTON #: VVXXXXXXXXXX	PACKED BY: XXXXXX	HP P/N: XXXXXX-XXX REV: XX
	BATCH #: CCVYMDRSS	L P/N: SW10K97515
		EC: 1404656

8265.D2WMLG MBB Label (After)

8265.D2WMLG	QTY: 1000	Intel® Dual Band Wireless-AC XXXX (Model: XXXXXXX)
VERSION #: J29934-006	MM#: XXXXXX	PKG ID (S): VVVVMMMMDDDDSSSSPPPPPP100
MADE IN CHINA WITH PARTIAL FOREIGN CONTENT	PACK DATE: DD MM YY	D P/N: PPPPPP REV AXX
CARTON #: VVXXXXXXXXXX	PACKED BY: XXXXXX	HP P/N: XXXXXX-XXX REV: XX
	BATCH #: CCVYMDRSS	L P/N: SW10K97515
		EC: 1404656

8265.D2WMLG IBL Label (Before)

8265.D2WMLG	QTY: 1000	Intel® Dual Band Wireless-AC XXXX (Model: XXXXXXX)
VERSION #: J29934-005	MM#: XXXXXX	PKG ID (S): VVVVMMMMDDDDSSSSPPPPPP100
MADE IN CHINA WITH PARTIAL FOREIGN CONTENT	PACK DATE: DD MM YY	D P/N: PPPPPP REV AXX
CARTON #: VVXXXXXXXXXX	PACKED BY: XXXXXX	HP P/N: XXXXXX-XXX REV: XX
	BATCH #: CCVYMDRSS	L P/N: SW10K97515
		EC: 1404656

8265.D2WMLG IBL Label (After)

8265.D2WMLG	QTY: 1000	Intel® Dual Band Wireless-AC XXXX (Model: XXXXXXX)
VERSION #: J29934-006	MM#: XXXXXX	PKG ID (S): VVVVMMMMDDDDSSSSPPPPPP100
MADE IN CHINA WITH PARTIAL FOREIGN CONTENT	PACK DATE: DD MM YY	D P/N: PPPPPP REV AXX
CARTON #: VVXXXXXXXXXX	PACKED BY: XXXXXX	HP P/N: XXXXXX-XXX REV: XX
	BATCH #: CCVYMDRSS	L P/N: SW10K97515
		EC: 1404656

<p>8265.D2WMLG.NV Reel Label (Before)</p> <p>8265.D2WML.NV R/ID: XXXXXXXXXXXX QTY: XXXX MM #: XXXXXX TA: J29943-005 HP P/N: XXXXXX-XXX REV XX T P/N: GTTTTTTTTTT XXXX-XXXXXXXXXXXXX L P/N: SW10K97516 D P/N: PPPPPP REV AX</p>	<p>8265.D2WMLG.NV Reel Label (After)</p> <p>8265.D2WML.NV R/ID: XXXXXXXXXXXX QTY: XXXX MM #: XXXXXX TA: J29943-006 HP P/N: XXXXXX-XXX REV XX T P/N: GTTTTTTTTTT XXXX-XXXXXXXXXXXXX L P/N: SW10K97516 D P/N: PPPPPP REV AX</p>
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8265.D2WMLG.NV MBB Label (Before)	
<p>8265.D2WMLG.NV QTY: 1000 MM#: XXXXXX VERSION #: J29943-005 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXX PACK DATE: DD MM YY PACKED BY: XXXXXX BATCH #: CCVYMDRSS</p>	<p>Intel® Dual Band Wireless-AC XXXX (Model: XXXXXXXX) PKG ID (S) VVVVMMMMGGGGGGPPPPPP100 T P/N: GTTTTTTTTTT D P/N: PPPPPP REV AX HP P/N: XXXXXX-XXX REV: XX PACKAGE WEIGHT: 3.3 LBS Vendor ID Loc ID Mfg ID VVVVVVVVVV VVVVVVVVVV VVVVVVVVVV L P/N: SW10K97516 EC: 1404656</p>

8265.D2WMLG.NV MBB Label (After)	
<p>8265.D2WMLG.NV QTY: 1000 MM#: XXXXXX VERSION #: J29943-006 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXX PACK DATE: DD MM YY PACKED BY: XXXXXX BATCH #: CCVYMDRSS</p>	<p>Intel® Dual Band Wireless-AC XXXX (Model: XXXXXXXX) PKG ID (S) VVVVMMMMGGGGGGPPPPPP100 T P/N: GTTTTTTTTTT D P/N: PPPPPP REV AX HP P/N: XXXXXX-XXX REV: XX PACKAGE WEIGHT: 3.3 LBS Vendor ID Loc ID Mfg ID VVVVVVVVVV VVVVVVVVVV VVVVVVVVVV L P/N: SW10K97516 EC: 1404656</p>

8265.D2WMLG.NV IBL Label (Before)	
<p>8265.D2WMLG.NV QTY: 1000 MM#: XXXXXX VERSION #: J29943-005 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXX PACK DATE: DD MM YY PACKED BY: XXXXXX BATCH #: CCVYMDRSS</p>	<p>Intel® Dual Band Wireless-AC XXXX (Model: XXXXXXXX) PKG ID (S) VVVVMMMMGGGGGGPPPPPP100 T P/N: GTTTTTTTTTT D P/N: PPPPPP REV AX HP P/N: XXXXXX-XXX REV: XX PACKAGE WEIGHT: 3.3 LBS Vendor ID Loc ID Mfg ID VVVVVVVVVV VVVVVVVVVV VVVVVVVVVV L P/N: SW10K97516 EC: 1404656</p>

8265.D2WMLG.NV IBL Label (After)	
<p>8265.D2WMLG.NV QTY: 1000 MM#: XXXXXX VERSION #: J29943-006 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXX PACK DATE: DD MM YY PACKED BY: XXXXXX BATCH #: CCVYMDRSS</p>	<p>Intel® Dual Band Wireless-AC XXXX (Model: XXXXXXXX) PKG ID (S) VVVVMMMMGGGGGGPPPPPP100 T P/N: GTTTTTTTTTT D P/N: PPPPPP REV AX HP P/N: XXXXXX-XXX REV: XX PACKAGE WEIGHT: 3.3 LBS Vendor ID Loc ID Mfg ID VVVVVVVVVV VVVVVVVVVV VVVVVVVVVV L P/N: SW10K97516 EC: 1404656</p>

<p>8265.D2WMLG.S Reel Label (Before)</p> <p>Intel 8265.D2WMLG.S R/ID: XXXXXXXXXX QTY: XXXX MM #: XXXXXX TA: J29950-004 HP P/N: XXXXXX-XXX REV XX T P/N: GDM48000217 XXXX-XXXXXXX L P/N: SW10K97482 D P/N: PXXXXP REV AXX</p>	<p>8265.D2WMLG.S Reel Label (After)</p> <p>Intel 8265.D2WMLG.S R/ID: XXXXXXXXXX QTY: XXXX MM #: XXXXXX TA: J29950-005 HP P/N: XXXXXX-XXX REV XX T P/N: GDM48000217 XXXX-XXXXXXX L P/N: SW10K97482 D P/N: PXXXXP REV AXX</p>
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<p>8265.D2WMLG.S MBB Label (Before)</p> <p>8265.D2WMLG.S QTY: 1000 VERSION #: J29950-004 MM#: XXXXXX MADE IN CHINA WITH PARTIAL FOREIGN CONTENT PACK DATE: DD MMM YY BATCH #: CCVYMDRSS</p>	<p>Intel® Dual Band Wireless-AC XXXX (Model: XXXXXXX)</p> <p>PKG ID (3S) VVVVMMMMDDG#####PPPPP100 T P/N: GDM48000217</p> <p>D P/N: PXXXXP REV AXX HP P/N: XXXXXX-XXX REV: XX PACKAGE WEIGHT: X.X LBS</p> <p>Vendor ID Loc Id Mfg Id VVVVVVVVVV VVVVVVVVVV VVVVVVVVVV</p> <p>L P/N: SW10K97482 EC: 336700</p>	<p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>Comit ID: 2016A3025 (M) PTA APPROVED MODEL</p> <p>CNC ID: C-19871 CNC ID: C-16283</p>
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<p>8265.D2WMLG.S MBB Label (After)</p> <p>8265.D2WMLG.S QTY: 1000 VERSION #: J29950-005 MM#: XXXXXX MADE IN CHINA WITH PARTIAL FOREIGN CONTENT PACK DATE: DD MMM YY BATCH #: CCVYMDRSS</p>	<p>Intel® Dual Band Wireless-AC XXXX (Model: XXXXXXX)</p> <p>PKG ID (3S) VVVVMMMMDDG#####PPPPP100 T P/N: GDM48000217</p> <p>D P/N: PXXXXP REV AXX HP P/N: XXXXXX-XXX REV: XX PACKAGE WEIGHT: X.X LBS</p> <p>Vendor ID Loc Id Mfg Id VVVVVVVVVV VVVVVVVVVV VVVVVVVVVV</p> <p>L P/N: SW10K97482 EC: 336700</p>	<p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>Comit ID: 2016A3025 (M) PTA APPROVED MODEL</p> <p>CNC ID: C-19871 CNC ID: C-16283</p>
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<p>8265.D2WMLG.S IBL Label (Before)</p> <p>8265.D2WMLG.S QTY: 1000 VERSION #: J29950-004 MM#: XXXXXX MADE IN CHINA WITH PARTIAL FOREIGN CONTENT PACK DATE: DD MMM YY BATCH #: CCVYMDRSS</p>	<p>Intel® Dual Band Wireless-AC XXXX (Model: XXXXXXX)</p> <p>PKG ID (3S) VVVVMMMMDDG#####PPPPP100 T P/N: GDM48000217</p> <p>D P/N: PXXXXP REV AXX HP P/N: XXXXXX-XXX REV: XX PACKAGE WEIGHT: X.X LBS</p> <p>Vendor ID Loc Id Mfg Id VVVVVVVVVV VVVVVVVVVV VVVVVVVVVV</p> <p>L P/N: SW10K97482 EC: 336700</p>	<p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>Comit ID: 2016A3025 (M) PTA APPROVED MODEL</p> <p>CNC ID: C-19871 CNC ID: C-16283</p>
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<p>8265.D2WMLG.S IBL Label (After)</p> <p>8265.D2WMLG.S QTY: 1000 VERSION #: J29950-005 MM#: XXXXXX MADE IN CHINA WITH PARTIAL FOREIGN CONTENT PACK DATE: DD MMM YY BATCH #: CCVYMDRSS</p>	<p>Intel® Dual Band Wireless-AC XXXX (Model: XXXXXXX)</p> <p>PKG ID (3S) VVVVMMMMDDG#####PPPPP100 T P/N: GDM48000217</p> <p>D P/N: PXXXXP REV AXX HP P/N: XXXXXX-XXX REV: XX PACKAGE WEIGHT: X.X LBS</p> <p>Vendor ID Loc Id Mfg Id VVVVVVVVVV VVVVVVVVVV VVVVVVVVVV</p> <p>L P/N: SW10K97482 EC: 336700</p>	<p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>Comit ID: 2016A3025 (M) PTA APPROVED MODEL</p> <p>CNC ID: C-19871 CNC ID: C-16283</p>
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<p>8265.D2WMLGH Reel Label (Before)</p>	<p>8265.D2WMLGH Reel Label (After)</p>
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<p>8265.D2WMLGH MBB Label (Before)</p>	<p>Intel® Dual Band Wireless-AC XXXX (Model: XXXXXXX)</p> <p>PKG ID (S) VVVVMMMMDDDDPPPPPP100</p> <p>T PIN: GTTTTTTTTTT</p> <p>D PIN: PPPPPP REV AXJ HP PIN: 851595-00 REV: 0E</p> <p>Vendor ID Loc Id Mfg Id VVVVVLLLLL </p> <p>L PIN: XXXXXXXXXX EC: XXXXXX</p>	<p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>COMIT ID: 2016A-0205 (M) PTA APPROVED MODEL</p> <p>CCAH16LP248T6</p> <p>CNC ID: C-17871 CNC ID: C-14263</p> <p>MSIP-CRM-INT-4216520W</p>
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<p>8265.D2WMLGH MBB Label (After)</p>	<p>Intel® Dual Band Wireless-AC XXXX (Model: XXXXXXX)</p> <p>PKG ID (S) VVVVMMMMDDDDPPPPPP100</p> <p>T PIN: GTTTTTTTTTT</p> <p>D PIN: PPPPPP REV AXJ HP PIN: 851595-00 REV: 0F</p> <p>Vendor ID Loc Id Mfg Id VVVVVLLLLL </p> <p>L PIN: XXXXXXXXXX EC: XXXXXX</p>	<p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>COMIT ID: 2016A-0205 (M) PTA APPROVED MODEL</p> <p>CCAH16LP248T6</p> <p>CNC ID: C-17871 CNC ID: C-14263</p> <p>MSIP-CRM-INT-4216520W</p>
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<p>8265.D2WMLGH IBL Label (Before)</p>	<p>Intel® Dual Band Wireless-AC XXXX (Model: XXXXXXX)</p> <p>PKG ID (S) VVVVMMMMDDDDPPPPPP100</p> <p>T PIN: GTTTTTTTTTT</p> <p>D PIN: PPPPPP REV AXJ HP PIN: 851595-00 REV: 0E</p> <p>Vendor ID Loc Id Mfg Id VVVVVLLLLL </p> <p>L PIN: XXXXXXXXXX EC: XXXXXX</p>	<p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>COMIT ID: 2016A-0205 (M) PTA APPROVED MODEL</p> <p>CCAH16LP248T6</p> <p>CNC ID: C-17871 CNC ID: C-14263</p> <p>MSIP-CRM-INT-4216520W</p>
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<p>8265.D2WMLGH IBL Label (After)</p>	<p>Intel® Dual Band Wireless-AC XXXX (Model: XXXXXXX)</p> <p>PKG ID (S) VVVVMMMMDDDDPPPPPP100</p> <p>T PIN: GTTTTTTTTTT</p> <p>D PIN: PPPPPP REV AXJ HP PIN: 851595-00 REV: 0F</p> <p>Vendor ID Loc Id Mfg Id VVVVVLLLLL </p> <p>L PIN: XXXXXXXXXX EC: XXXXXX</p>	<p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>COMIT ID: 2016A-0205 (M) PTA APPROVED MODEL</p> <p>CCAH16LP248T6</p> <p>CNC ID: C-17871 CNC ID: C-14263</p> <p>MSIP-CRM-INT-4216520W</p>
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<p>8265.D2WMLG.NVH Reel Label (Before)</p>	<p>8265.D2WMLG.NVH Reel Label (After)</p>
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<p>8265.D2WMLG.NVH</p> <p>MM#: XXXXXX QTY: 1000</p> <p>VERSION #: J39997-005</p> <p>MADE IN CHINA WITH PARTIAL FOREIGN CONTENT</p> <p>PACK DATE: DD MMM YY PACKED BY: XXXXXX</p> <p>BATCH #: CCVYMDRSS</p>	<p>Intel® Dual Band Wireless-AC XXXX (Model: XXXXXXX)</p> <p>PKG ID (3S) VVVVMMMMDD000000PPPP100</p> <p>T P/N: GTTTTTTTTT</p> <p>D P/N: PPPPPP REV AXJ HP P/N: 851597-001 REV: 0E</p> <p>Vendor ID Loc Id Mfg Id</p> <p>L P/N: XXXXXXXXXX EC: XXXXXX</p>	<p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>CCAH/HP124876</p> <p>003-100129</p> <p>CNC ID: C-17871 CNC ID: C-14283</p> <p>MSIP-CRM-ANT-8265D2V</p>
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<p>8265.D2WMLG.NVH</p> <p>MM#: XXXXXX QTY: 1000</p> <p>VERSION #: J39997-006</p> <p>MADE IN CHINA WITH PARTIAL FOREIGN CONTENT</p> <p>PACK DATE: DD MMM YY PACKED BY: XXXXXX</p> <p>BATCH #: CCVYMDRSS</p>	<p>Intel® Dual Band Wireless-AC XXXX (Model: XXXXXXX)</p> <p>PKG ID (3S) VVVVMMMMDD000000PPPP100</p> <p>T P/N: GTTTTTTTTT</p> <p>D P/N: PPPPPP REV AXJ HP P/N: 851597-001 REV: 0F</p> <p>Vendor ID Loc Id Mfg Id</p> <p>L P/N: XXXXXXXXXX EC: XXXXXX</p>	<p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>CCAH/HP124876</p> <p>003-100129</p> <p>CNC ID: C-17871 CNC ID: C-14283</p> <p>MSIP-CRM-ANT-8265D2V</p>
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<p>8265.D2WMLG.NVH</p> <p>MM#: XXXXXX QTY: 1000</p> <p>VERSION #: J39997-005</p> <p>MADE IN CHINA WITH PARTIAL FOREIGN CONTENT</p> <p>PACK DATE: DD MMM YY PACKED BY: XXXXXX</p> <p>BATCH #: CCVYMDRSS</p>	<p>Intel® Dual Band Wireless-AC XXXX (Model: XXXXXXX)</p> <p>PKG ID (3S) VVVVMMMMDD000000PPPP100</p> <p>T P/N: GTTTTTTTTT</p> <p>D P/N: PPPPPP REV AXJ HP P/N: 851597-001 REV: 0E</p> <p>Vendor ID Loc Id Mfg Id</p> <p>L P/N: XXXXXXXXXX EC: XXXXXX</p>	<p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>CCAH/HP124876</p> <p>003-100129</p> <p>CNC ID: C-17871 CNC ID: C-14283</p> <p>MSIP-CRM-ANT-8265D2V</p>
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<p>8265.D2WMLG.NVH</p> <p>MM#: XXXXXX QTY: 1000</p> <p>VERSION #: J39997-006</p> <p>MADE IN CHINA WITH PARTIAL FOREIGN CONTENT</p> <p>PACK DATE: DD MMM YY PACKED BY: XXXXXX</p> <p>BATCH #: CCVYMDRSS</p>	<p>Intel® Dual Band Wireless-AC XXXX (Model: XXXXXXX)</p> <p>PKG ID (3S) VVVVMMMMDD000000PPPP100</p> <p>T P/N: GTTTTTTTTT</p> <p>D P/N: PPPPPP REV AXJ HP P/N: 851597-001 REV: 0F</p> <p>Vendor ID Loc Id Mfg Id</p> <p>L P/N: XXXXXXXXXX EC: XXXXXX</p>	<p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>CCAH/HP124876</p> <p>003-100129</p> <p>CNC ID: C-17871 CNC ID: C-14283</p> <p>MSIP-CRM-ANT-8265D2V</p>
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- The Intel Tracking revision will be changed on the following products:

SKU	Before	After
8265.D2WMLGH	0E	0F
8265.D2WMLG.NVH	0E	0F

Customer Impact of Change and Recommended Action:

The label changes to the products do not affect functionality. Intel anticipates no impact to customers.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes

*Other names and brands may be claimed as the property of others.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
8265.D2WMLGH	953394	J39985-005	J39985-006
8265.D2WMLG.NVH	953395	J39997-005	J39997-006
8265.D2WMLG	946657	J29934-005	J29934-006
8265.D2WMLG.NV	949401	J29943-005	J29943-006
8265.D2WMLG.S	949745	J29950-004	J29950-005
8265.D2WMLG.NVS	951077	J29959-004	J29959-005

PCN Revision History:

Date of Revision:

February 5, 2019

Revision Number:

00

Reason:

Originally Published PCN



Product Change Notification

116754 - 00

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The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apagccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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